X00619

0.8 A sensitive gate SCR

Features

- $I_{T(RMS)}$ = 0.8 A
- V_{DRM}, V_{RRM} = 600 V
- I_{GT} = 30 to 200 μA

Applications

- Limited gate current topologies
- Ground fault circuit interrupters
- Overvoltage crowbar protection in power supplies
- Protection in electronic ballasts
- Capacitive discharge ignitions
- Ignitors (lighting, oven...)

Description

The X006 SCR can be used as on/off function in applications where topology does not offer high current for gate triggering.

This device is optimized in forward voltage drop and inrush current capabilities for reduced power losses and high reliability in harsh environments.
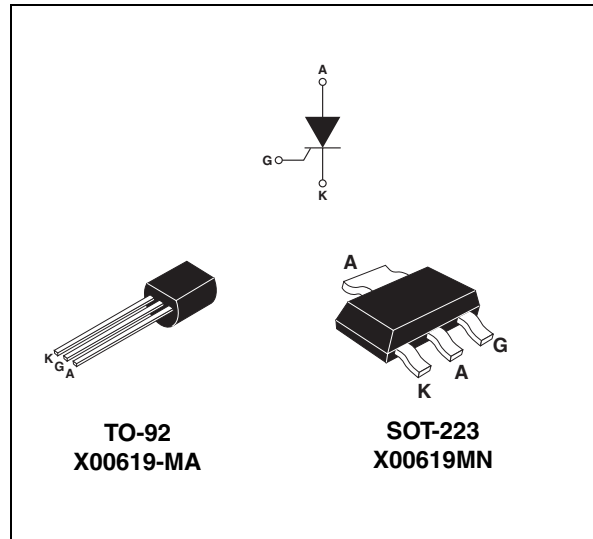

TO-92
X00619-MA

SOT-223
X00619MN

Table 1.   Device summary

$I_{T(RMS)}$	0.8 A
V_{DRM} / V_{RRM}	600 V
I_{GT}	30 to 200 μA

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1 Characteristics

Table 2. Absolute ratings (limiting values, T_j = 25 °C unless otherwise specified)

Symbol	Parameter			Value	Unit
$I_{T(RMS)}$	On-state rms current (180 °Conduction angle)	TO-92	T_L = 83 °C	0.8	A
		SOT-223	T_c = 107 °C		
$IT_{(AV)}$	Average on-state current (180 °Conduction angle)	TO-92	T_L = 83 °C	0.5	A
		SOT-223	T_c = 107 °C		
I_{TSM}	Non repetitive surge peak on-state current	t_p = 8.3 ms	T_j = 25 °C	10	A
		t_p = 10 ms		9	
I^2t	I^2t Value for fusing	t_p = 10 ms	T_j = 25 °C	0.4	A^2s
di/dt	Critical rate of rise of on-state current I_G = 2 x I_{GT}, $t_r \leq$ 100 ns	F = 60 Hz	T_j = 125 °C	50	A/µs
I_{GM}	Peak gate current	t_p = 20 µs	T_j = 125 °C	1	A
$P_{G(AV)}$	Average gate power dissipation		T_j = 125 °C	0.1	W
T_{stg} T_j	Storage junction temperature range Operating junction temperature range			- 40 to + 150 - 40 to + 125	°C

Table 3. Electrical characteristics (T_j = 25 °C unless otherwise specified)

Symbol	Test conditions			Value	Unit
I_{GT}	V_D = 12 V, R_L = 140 Ω		MIN.	30	µA
			MAX.	200	
V_{GT}				0.8	V
V_{GD}	V_D = V_{DRM}, R_L = 3.3 kΩ, R_{GK} = 1 kΩ	T_j = 125 °C	MIN.	0.2	V
V_{RG}	I_{RG} = 10 µA		MIN.	5	V
I_H	I_T = 50 mA, R_{GK} = 1 kΩ		MAX.	5	mA
I_L	I_G = 1 mA, R_{GK} = 1 kΩ		MAX.	6	mA
dV/dt	V_D = 67% V_{DRM}, R_{GK} = 1 kΩ	T_j = 125 °C	MIN.	40	V/µs

Table 4. Static electrical characteristics

Symbol	Test conditions			Value	Unit
V_{TM}	I_{TM} = 1 A, t_p = 380 µs	T_j = 25 °C		1.35	V
V_{TO}	Threshold voltage	T_j = 125 °C	MAX	0.85	V
R_d	Dynamic resistance			245	mΩ
$I_{DRM} I_{RRM}$	V_{DRM} = V_{RRM}, R_{GK} = 1 kΩ	T_j = 25 °C		1	µA
		T_j = 125 °C		100	µA

Table 5.   Thermal resistances

Symbol	Parameter			Value	Unit
$R_{th(j-l)}$	Junction to leads (DC)	TO-92	Max.	70	°C/W
$R_{th(j-c)}$	Junction to case (DC)	SOT-223		30	
$R_{th(j-a)}$	Junction to ambient (DC)	TO-92		150	
		$S = 5\ cm^2$ SOT-223		60	

Figure 1.   Maximum average power dissipation versus average on-state current

Figure 2.   Average and DC on-state current versus case temperature (SOT-223)

Figure 3.   Average and DC on-state current versus lead temperature (TO-92)

Figure 4.   Average and DC on-state current versus ambient temperature (free air convection)

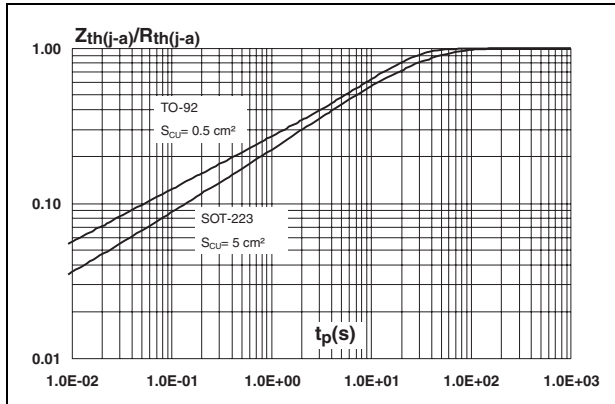**Figure 5.** **Relative variation of thermal impedance junction to ambient versus pulse duration**

Figure 6. **Relative variation of gate trigger, holding and latching current versus junction temperature**

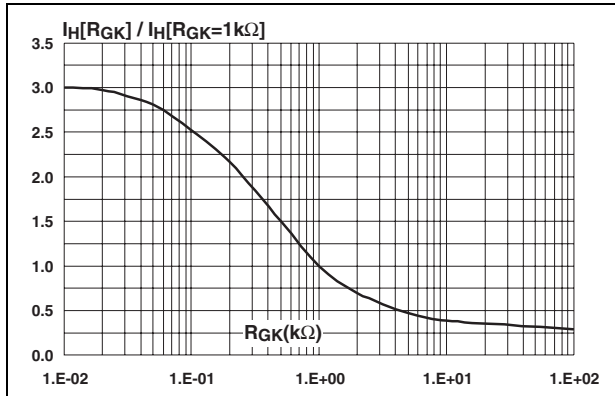**Figure 7.** **Relative variation of holding current versus gate-cathode resistance (typical values)**

Figure 8. **Relative variation of dV/dt immunity versus gate-cathode resistance (typical values)**

Figure 9. **Relative variation of dV/dt immunity versus gate-cathode capacitance (typical values)**
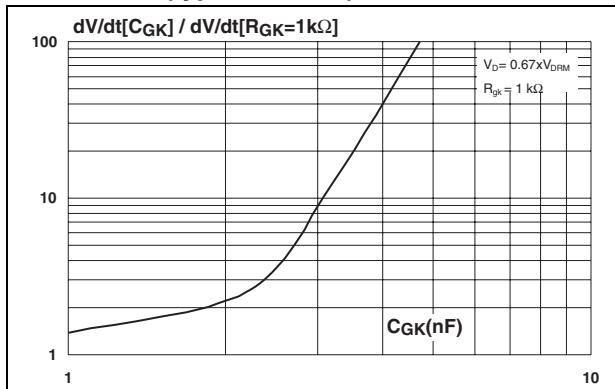

Figure 10. **Surge peak on-state current versus number of cycles**

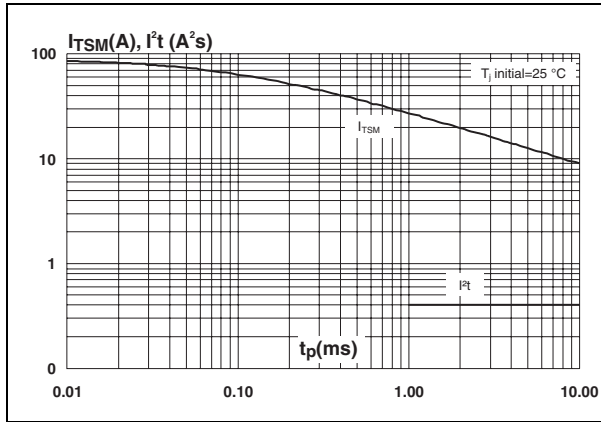**Figure 11. Non repetitive surge peak on state current for a sinusoidal pulse and corresponding value of I^2T**

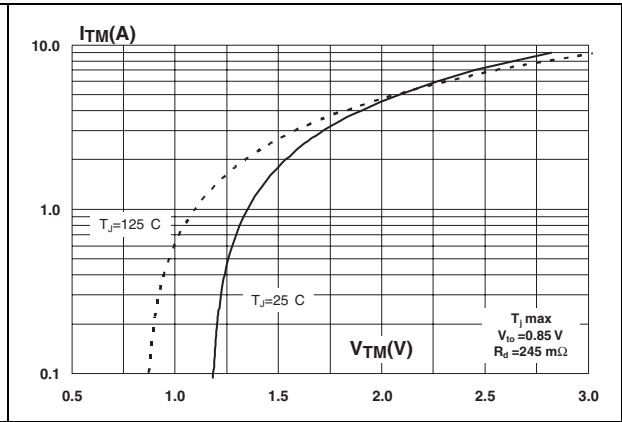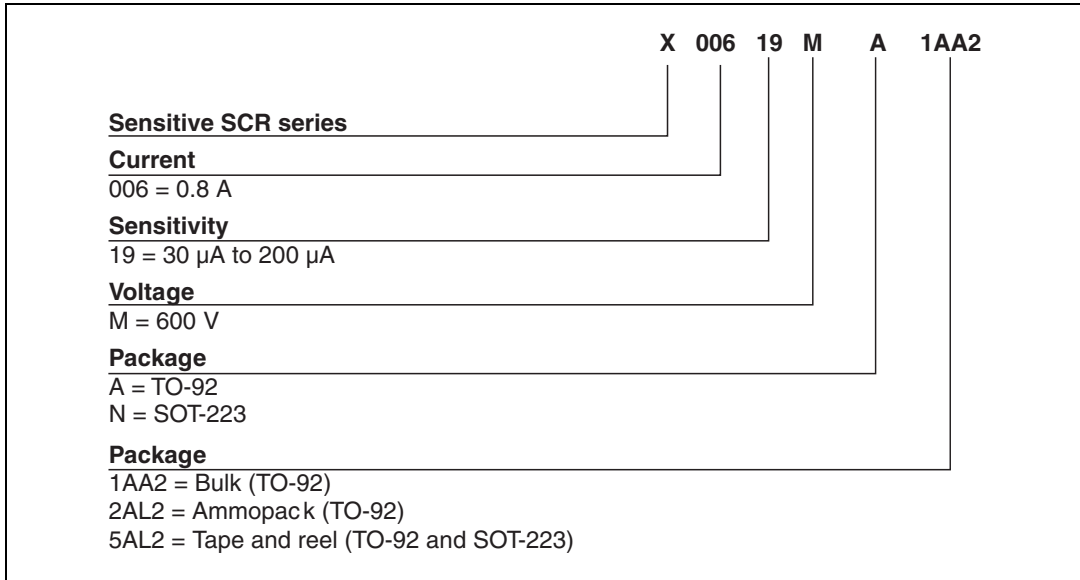**Figure 12. On-state characteristics (maximum values)**

Figure 13. Thermal resistance junction to ambient versus copper surface under tab (SOT-223)

2   Ordering information scheme

Figure 14.   Ordering information scheme

3   Package information

● Epoxy meets UL94, V0

● Lead-free packages

In order to meet environmental requirements, ST offers these devices in different grades of
ECOPACK$^®$ packages, depending on their level of environmental compliance. ECOPACK$^®$
specifications, grade definitions and product status are available at: www.st.com.
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Table 6.   TO-92 (plastic) dimensions

Ref.	Dimensions					
	Millimeters			**Inches**		
	Min.	**Typ.**	**Max.**	**Min.**	**Typ.**	**Max.**
A	-	1.35	-	-	0.053	-
B	-	-	4.70	-	-	0.185
C	-	2.54	-	-	0.100	-
D	4.40	-	-	0.173	-	-
E	12.70	-	-	0.500	-	-
F	-	-	3.70	-	-	0.146
a	-	-	0.50	-	-	0.019
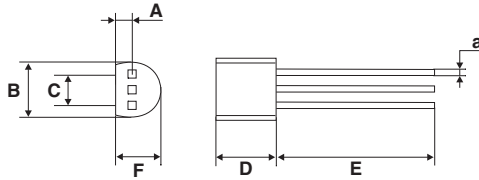
Table 7. SOT-223 dimensions

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.80			0.071
A1		0.02	0.10		0.001	0.004
B	0.60	0.70	0.85	0.024	0.027	0.033
B1	2.90	3.00	3.15	0.114	0.118	0.124
c	0.24	0.26	0.35	0.009	0.010	0.014
D[1]	6.30	6.50	6.70	0.248	0.256	0.264
e		2.3			0.090	
e1		4.6			0.181	
E[1]	3.30	3.50	3.70	0.130	0.138	0.146
H	6.70	7.00	7.30	0.264	0.276	0.287
V	10° max					

1. Do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15mm (0.006inches)

Figure 15. SOT-223 footprint
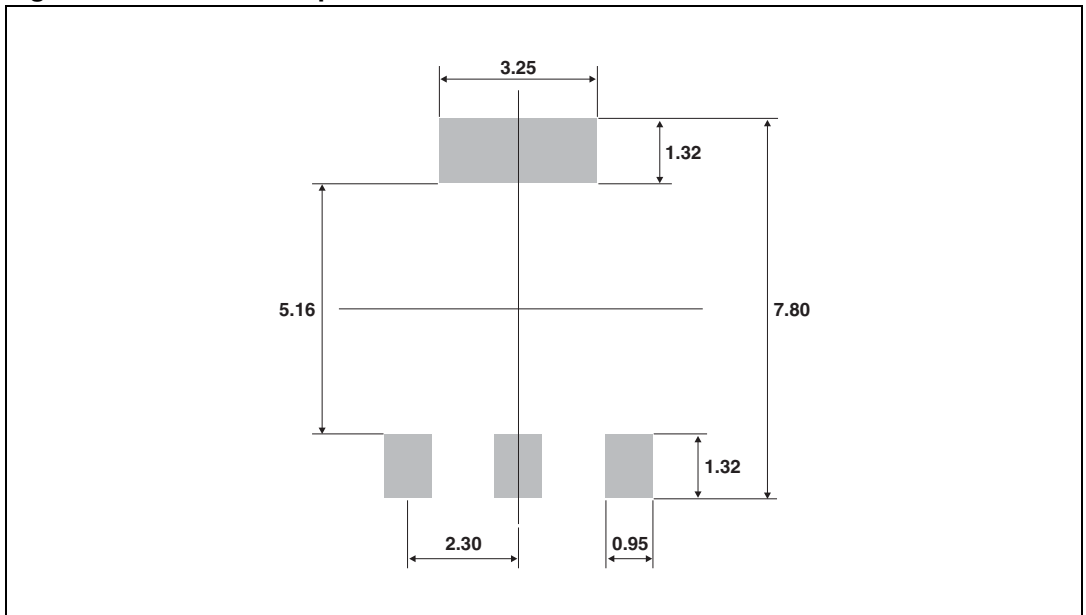
4 Ordering information

Table 8.   Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
X00619MA1AA2	X0619 MA	TO-92	0.2 g	2500	Bulk
X00619MA2AL2				2000	Ammopack
X00619MA5AL2				2000	Tape and reel
X00619MN5AL2	X0 619 MN	SOT-223	0.12 g	1000	

5 Revision history

Table 9.   Document revision history

Date	Revision	Changes
26-May-2009	1	First issue
03-May-2012	2	Added SOT-223 package.

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